

# DAP miniWiggler V3

## About this document

### Scope and purpose

This document provides details of DAP miniWiggler V3.1, which is the successor of DAP miniWiggler V2.0.

### Intended audience

This document is intended for tool partners and users. This application note assumes that the reader knows the tool interfaces of Infineon devices.

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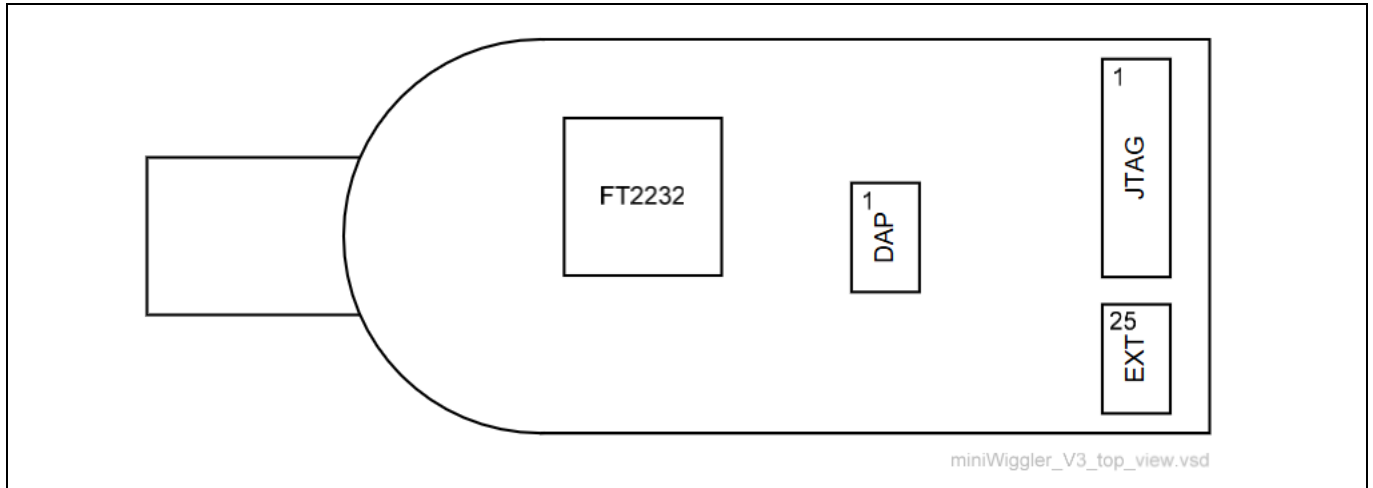
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## Introduction

### 1 Introduction

Figure 1 shows the location and orientation of the different connectors.



**Figure 1** DAP miniWiggler V3.1

#### Important notes:

- Never connect the DAP cable to the EXT connector of the miniWiggler. This will destroy the target and/or the miniWiggler
- Never connect both JTAG and DAP cables to targets at the same time
- In case of JTAG please make sure that the JPD pin is connected to GND on target side

#### 1.1 Comparison with DAP miniWiggler V2.0

- RESET pin is controlled with pull-down transistor
- UART RXD is connected to SWV pin on SWD/DAP connector
- Large OCDS L1 connector is replaced by small 20 pin Automotive JTAG connector
- Connector for frontend extensions (e.g. for galvanic isolation) added
- USER1/DAPEN pin has a strong pull-up. Allows DAP hot attach if device is powered first

## Automotive JTAG Connector

## 2 Automotive JTAG Connector

This 20-pin connector in two rows with 1.27 mm pitch is a space saving alternative to the OCDS L1 connector. The pin layout is compatible with Lauterbach's 20 pin Automotive Connector (AUTO-20) [6].

**Table 1 Automotive JTAG Connector on Target Board**

Pin	Name	Dir.	Description
1	VREF	O	Supply voltage from the target system. It has to be strong enough to supply the target side of the level shifters within the tool hardware up to about 10 MHz JTAG operating frequency. The required supply current is in the range of 1 to 5 mA, mainly caused by signal switching. It can be reduced by lower frequency and capacitance.
2	TMS	I	JTAG TMS signal.
3	GND	–	–
4	TCK	I	JTAG TCK signal.
5	GND	–	–
6	TDO	O	JTAG TDO signal.
7	KEY (GND in cable)	-	If the connector on the board has no keying shroud, this pin provides another option to enforce polarization. For that this pin is removed from the target connector and the associated jack in the cable connector closed.
8	TDI	I	JTAG TDI signal.
9	GND	–	–
10	RESET	IO	Low active target reset signal. Open drain active low signal. May be used bi-directionally to drive or sense the target reset signal. Usually driven by the tool to reset the target system. The target system is responsible for providing a pull up to VREF on this signal to establish a logic one. The resistor shall not have a value less than 1 kOhms.
11	GND	–	–
12	RESETOUT	O	Optional low active reset output signal. Left open on tool side if not supported by tool.
13	GND	–	–
14	USER1	I(O)	Optional user defined IO pin e.g. for WDTDIS or /OCDSE. Default direction is input and default level is High. Pulled (10kR) to VREF on tool side if not supported by tool.
15	GND	–	–
16	TRST	I	Low active JTAG reset.
17	GND	–	–
18	TGI_RXD	IO	Low active trigger in (default) or out signal Or UART RXD input of device.
19	GND	–	Target presence detection. Connected to GND on target side. Pull-up and sensing on tool side.
20	USER0_TXD	IO	Optional user defined IO pin. Or UART TXD output of device.

## Automotive JTAG Connector

### 2.1 Comparison with OCDS L1 Connector

The larger OCDS L1 connector is specified in AP24001 [5].

**Table 2 Comparison with OCDS L1 Connector**

Automotive	OCDS L1	Comment
VREF	VDD	–
TMS	TMS	–
TCK	TCK	–
TDO	TDO	–
TDI	TDI	–
RESET	RESET	–
TGI_RXD	BRKIN	New trigger pin naming starting with AURIX devices. Optional RXD function.
TGO_TXD	BRKOUT	New trigger pin naming starting with AURIX devices. Optional TXD function.
USER0	–	Automotive connector is aligned with DAP connector
USER1	–	Automotive connector is aligned with DAP connector
–	RCAP1	Undefined behavior
–	RCAP2	Undefined behavior
–	OCDSE	Obsolete
–	CPU_CLOCK	Obsolete

## Frontend Connector (JTAG + EXT)

### 3 Frontend Connector (JTAG + EXT)

Additional 10 pins (EXT) for a 34 pin cable are used. There is a gap of 4 pins to allow the plugging of the 20-pin JTAG connector.

**Table 3 Frontend Connector (JTAG + EXT)**

Pin	Name	DAP	Dir.	Comment
1	VREF		I	–
2	TMS	–	O	–
3	GND		–	–
4	TCK	DAP0	O	–
5	GND		–	–
6	TDO	DAP1	I/IO	Note that this DAP/JTAG signal mapping is not compliant with the standard DAP1/TMS mapping on device side.
7	GND		–	–
8	TDI	DAP10	O	DAP1 output signal in case of DAP and galvanic isolation.
9	GND		–	–
10	RESET		O	–
11	GND		–	–
12	RESETOUT		I	Not supported. Left open.
13	GND		–	–
14	USER1		IO	Just output direction in case of galvanic isolation.
15	GND		–	–
16	TRST	USER8	O	–
17	GND		–	–
18	TXD		O	Connects to RXD input of device. Voltage level is VREF.
19	JPD		I	JTAG presence detection with internal pull-up. Connect to GND on target side if the target uses the JTAG interface.
20	USER0_RXD		IO	USER0: Default is input. Only input case of galvanic isolation. RXD: Connects to TXD output of device. Voltage level is VREF.
21, 23	GND		–	Connector gap – not assembled.
22, 24	VSUP5		O	Connector gap – not assembled. (5 V supply for frontend)
25	GND		–	–
26	–	DAPDIR	O	DAP1 direction. Low for direction target out to tool in.
27	GND		–	–
28	DAP1PULL		O	For optional control of DAP1 pull-up/down resistor.
29	GND		–	–
30	FEI0		–	Frontend identification 0 with internal pull-up.
31	VSUP33		O	3.3 V supply for frontend
32	FEI1		–	Frontend identification 1 with internal pull-up.
33	VSUP33		O	3.3 V supply for frontend
34	FEI2		–	Frontend identification 2 with internal pull-up.

Frontend Identifiers

## 4 Frontend Identifiers

FEIx pins are connected to FT2232 BCBUSx pins similar to JPD connected to ADBUS5 pins.

*Note: Frontend boards may only pull (5kR) FEIx signals and not hardwire them. The reason is that the FT2232 may come up in a mode where it drives the FEIx signals. It is only needed to pull to GND, since the FT2232 has internal pull-ups active.*

**Table 4 Frontend Identifiers (FEIx Pins)**

FEIx 2-1-0	Comment
H-H-H	No frontend or transparent frontends like connector adaptors
H-H-L	Galvanic isolation frontend JTAG or DAP/SPD/SWD decided with JPD pin level. Operating frequency is limited to 10 MHz. DAP10 operated as output. DAP1, DAP10, DAPDIR and DAPPULL are operated as unidirectional signals. Note that DAP1 is still bidirectional in the DAP miniWiggler V3.1 design. For a simple galvanic isolation frontend a resistor can be used to limit the current of frontend and miniWiggler are driving DAP1.
H-L-H	CAN transceiver for DXCPL (DAP over CAN Physical Layer).
Other	Reserved

### 5 Target Communication

Supports DAS infrastructure [1] with MCD API [2] as interface.

The DAP miniWiggler V3 [3] provides an R/W latency to the target 150  $\mu$ s for single accesses and up to 2 MByte/s bandwidth for block data accesses. This bandwidth depends on the frequency, used protocol and device type. The highest performance is achieved with a direct connection to a fast highspeed USB port of the host computer for DAP and AURIX devices at 30 MHz.

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## References

### References

- [1] Infineon Technologies AG: *DAS (Device Access Server)*; [Available online](#)
- [2] Infineon Technologies AG: *MCD API (Multi-Core Debug)*; [Available online](#)
- [3] Infineon Technologies AG: *DAP miniWiggler*; [Available online](#)
- [4] Infineon Technologies AG: *AP24003 DAP Connector*; [Available online](#)
- [5] Infineon Technologies AG: *AP24001 OCDS Level 1 JTAG Connector*; [Available online](#)
- [6] Lauterbach Automotive Debug Connector (AUTO-20); [Available online](#)

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## Revision history

### Revision history

Document revision	Date	Description of changes
1.0	2013-07-01	Initial version
1.1	2025-04-25	Updated template

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